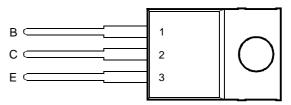
- Designed for Complementary Use with the TIP32 Series
- 40 W at 25°C Case Temperature
- 3 A Continuous Collector Current
- 5 A Peak Collector Current
- Customer-Specified Selections Available

#### TO-220 PACKAGE (TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRACA

## absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT	
	TIP31		80	
Collector base voltage (I = 0)	TIP31A	V	100	V
Collector-base voltage (I <sub>E</sub> = 0)	TIP31B	V <sub>CBO</sub>	120	
	TIP31C		140	
	TIP31		40	
Collector-emitter voltage (I <sub>B</sub> = 0)	TIP31A	V	60	V
	TIP31B	V <sub>CEO</sub>	80	V
	TIP31C		100	
Emitter-base voltage	V <sub>EBO</sub>	5	V	
Continuous collector current			3	Α
Peak collector current (see Note 1)			5	Α
Continuous base current			1	Α
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)			40	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)			2	W
Unclamped inductive load energy (see Note 4)			32	mJ
Operating junction temperature range			-65 to +150	°C
Storage temperature range			-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds	T <sub>L</sub>	250	°C	

NOTES: 1. This value applies for  $t_p \le 0.3$  ms, duty cycle  $\le 10\%$ .

- 2. Derate linearly to 150°C case temperature at the rate of 0.32 W/°C.
- 3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.
- 4. This rating is based on the capability of the transistor to operate safely in a circuit of: L = 20 mH,  $I_{B(on)}$  = 0.4 A,  $R_{BE}$  = 100  $\Omega$ ,  $V_{BE(off)}$  = 0,  $R_{S}$  = 0.1  $\Omega$ ,  $V_{CC}$  = 20 V.



# TIP31, TIP31A, TIP31B, TIP31C NPN SILICON POWER TRANSISTORS

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# electrical characteristics at 25°C case temperature

PARAMETER			TEST CONDITION	ONS	MIN TYP			UNIT
V <sub>(BR)CEO</sub>	Collector-emitter breakdown voltage	I <sub>C</sub> = 30 mA (see Note 5)	I <sub>B</sub> = 0	TIP31 TIP31A TIP31B TIP31C	40 60 80 100			V
I <sub>CES</sub>	Collector-emitter cut-off current	$V_{CE} = 80 \text{ V}$ $V_{CE} = 100 \text{ V}$ $V_{CE} = 120 \text{ V}$ $V_{CE} = 140 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	TIP31 TIP31A TIP31B TIP31C			0.2 0.2 0.2 0.2	mA
I <sub>CEO</sub>	Collector cut-off current	$V_{CE} = 30 \text{ V}$ $V_{CE} = 60 \text{ V}$	$I_{B} = 0$ $I_{B} = 0$	TIP31/31A TIP31B/31C			0.3 0.3	mA
I <sub>EBO</sub>	Emitter cut-off current	V <sub>EB</sub> = 5 V	I <sub>C</sub> = 0				1	mA
h <sub>FE</sub>	Forward current transfer ratio	$V_{CE} = 4 V$ $V_{CE} = 4 V$	I <sub>C</sub> = 1 A I <sub>C</sub> = 3 A	(see Notes 5 and 6)	25 10		50	
V <sub>CE(sat)</sub>	Collector-emitter saturation voltage	I <sub>B</sub> = 375 mA	I <sub>C</sub> = 3 A	(see Notes 5 and 6)			1.2	٧
$V_{BE}$	Base-emitter voltage	V <sub>CE</sub> = 4 V	I <sub>C</sub> = 3 A	(see Notes 5 and 6)			1.8	V
h <sub>fe</sub>	Small signal forward current transfer ratio	V <sub>CE</sub> = 10 V	I <sub>C</sub> = 0.5 A	f = 1 kHz	20			
h <sub>fe</sub>	Small signal forward current transfer ratio	V <sub>CE</sub> = 10 V	I <sub>C</sub> = 0.5 A	f = 1 MHz	3			

NOTES: 5. These parameters must be measured using pulse techniques,  $t_p$  = 300  $\mu$ s, duty cycle  $\leq$  2%.

## thermal characteristics

PARAMETER			TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			3.125	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

# resistive-load-switching characteristics at 25°C case temperature

	PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t <sub>or</sub>	n Turn-on time	I <sub>C</sub> = 1 A	$I_{B(on)} = 0.1 A$	$I_{B(off)} = -0.1 A$		0.5		μs
t <sub>of</sub>	ff Turn-off time	$V_{BE(off)} = -4.3 \text{ V}$	$R_L = 30 \Omega$	$t_p = 20 \ \mu s, \ dc \le 2\%$		2		μs

 $<sup>^{\</sup>dagger} \ \ \mbox{Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.}$ 

<sup>6.</sup> These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

# **TYPICAL CHARACTERISTICS**

# **TYPICAL DC CURRENT GAIN COLLECTOR CURRENT** TCS631AA 1000 V<sub>CE</sub> = 4 V $T_c = 25^{\circ}C$ $t_p = 300 \mu s$ , duty cycle < 2% h<sub>FE</sub> - DC Current Gain 100 10 0.001 0.01 0-1 1.0 10 I<sub>C</sub> - Collector Current - A

# **COLLECTOR-EMITTER SATURATION VOLTAGE**

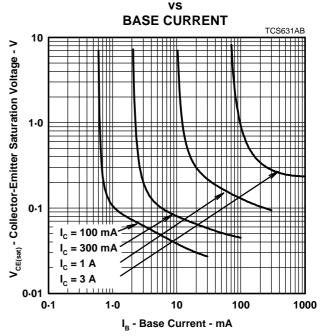
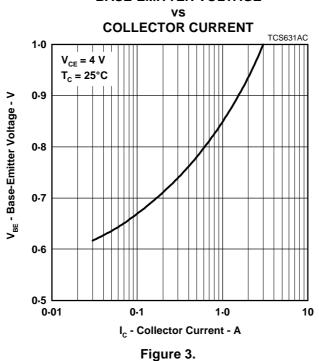


Figure 2.

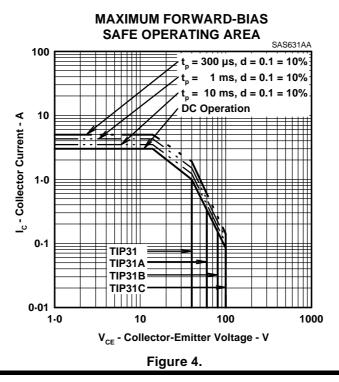
# Figure 1.

### **BASE-EMITTER VOLTAGE**





#### **MAXIMUM SAFE OPERATING REGIONS**



### THERMAL INFORMATION

### **MAXIMUM POWER DISSIPATION**

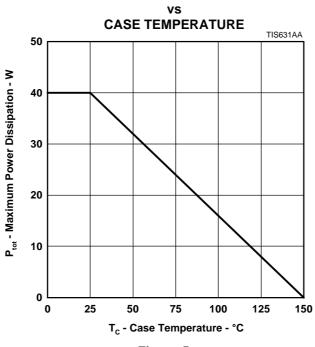


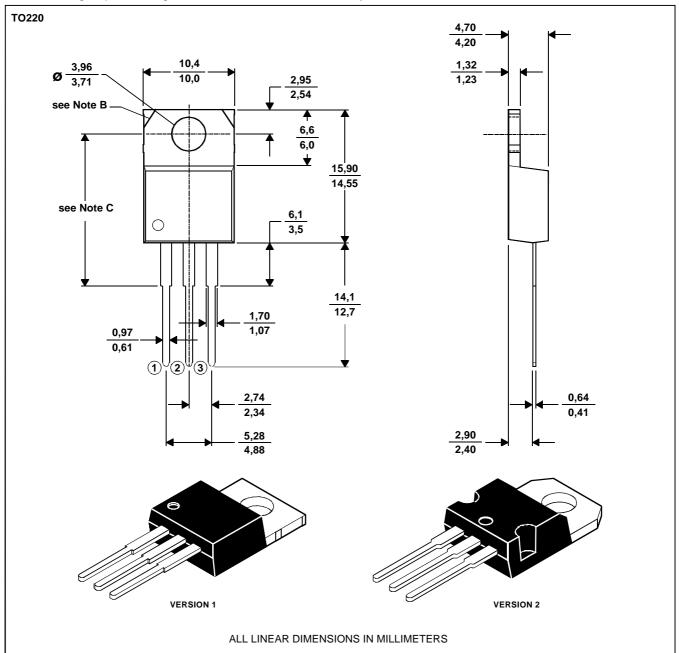
Figure 5.

#### **MECHANICAL DATA**

#### **TO-220**

## 3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTES: A. The centre pin is in electrical contact with the mounting tab.

B. Mounting tab corner profile according to package version.

C. Typical fixing hole centre stand off height according to package version. Version 1, 18.0 mm. Version 2, 17.6 mm. MDXXBE



# TIP31, TIP31A, TIP31B, TIP31C NPN SILICON POWER TRANSISTORS

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